





IN THE UNITED STATES PATENT AND TRADEMARK OFFICE  
(Case No. 05-040)

PATENT

In the Application of:

Heylbroeck et al. )  
Serial No.: 10/521,915 )  
Filing Date: January 20, 2005 )  
For: In-Line Demetallization Process for )  
Flexible Metallized Substrates )

Examiner: Culbert, R.P.

Group Art Unit: 1763

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**TRANSMITTAL LETTER**

In regard to the above identified application:

1. We are transmitting herewith the attached:
2. a. Transmittal Letter (in duplicate);  
b. Request for Continued Examination; and  
c. Postcard.
3. Check in the amount of \$790.00 is enclosed.
4. Please charge any additional fees or credit overpayment to Deposit Account No.13-2490.

Respectfully submitted,

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CERTIFICATE OF MAILING UNDER 37 CFR § 1.8: The undersigned hereby certifies that this Transmittal Letter and the papers, as described in paragraph 1 hereinabove, are being deposited with the United States Postal Service with sufficient postage as U.S. Express Mail No. EV839381103US in an envelope addressed to: Commissioner for Patents, Alexandria, VA 22313-1450 on this 14 day of September, 2007.

